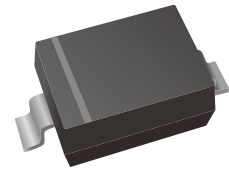


Surface Mount Schottky Barrier Rectifier

Features

- Metal silicon junction, majority carrier conduction
- Guarding for overvoltage protection
- Low power loss, high efficiency
- High current capability
- Low forward voltage drop
- High surge capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- Lead free in comply with EU RoHS 2011/65/EU directives



Mechanical Data

- Case: SOD-323
- Terminals: Solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end

Ordering Information

Part Number	Marking	Shipping	Reel
LT54SW-TR3	L9	3000PCS Tape&Reel	7 inchs
LT54SW-TR12	L9	12000PCS Tape&Reel	13 inchs

Maximum Ratings and Electrial characteristics

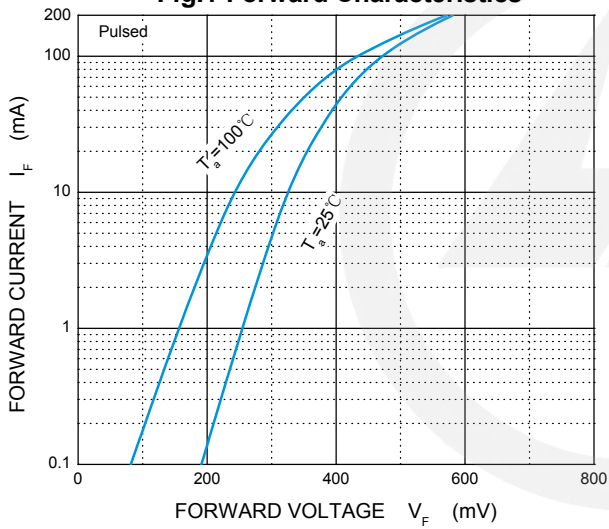
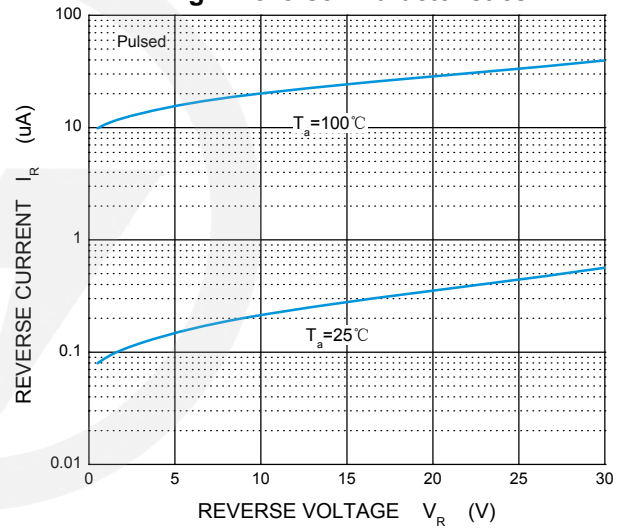
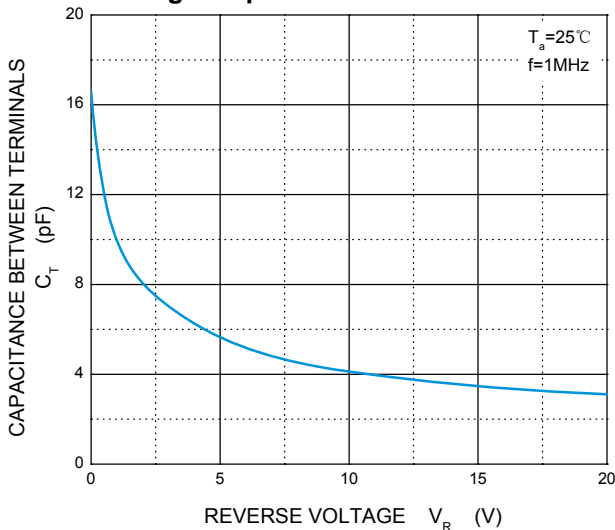
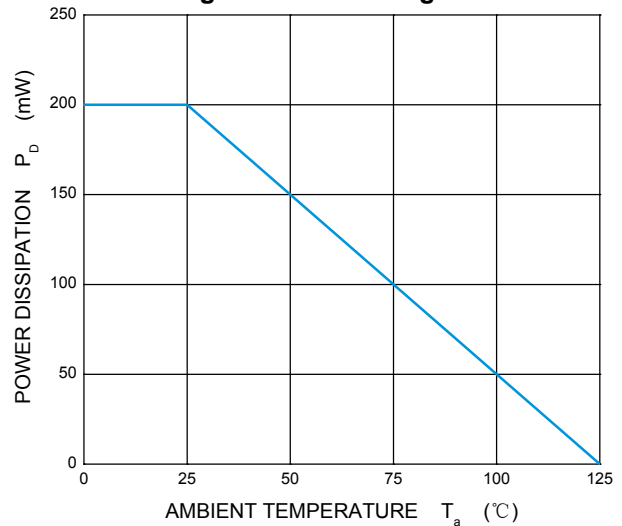
Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter	Symbol	Limit	Unit
Non-Repetitive Peak Reverse Voltage	V_{RM}	30	V
DC Blocking Voltage	V_R	21	V
Average Rectified Output Current	I_o	100	mA
Forward current	I_F	0.2	A
Repetitive Peak Forward Current	I_{FRM}	0.3	A
Non-Repetitive Peak forward surge current @t=8.3 ms	I_{FSM}	0.6	A
Typical thermal resistance	$R_{\theta JA}$	500	°C/W
Power Dissipation	PD	200	mW
Junction Temperature	T_j	125	°C
Storage temperature range	T_{STG}	-50-+150	°C

Note:(1) P.C.B. mounted with 5mm*5mm copper pad areas

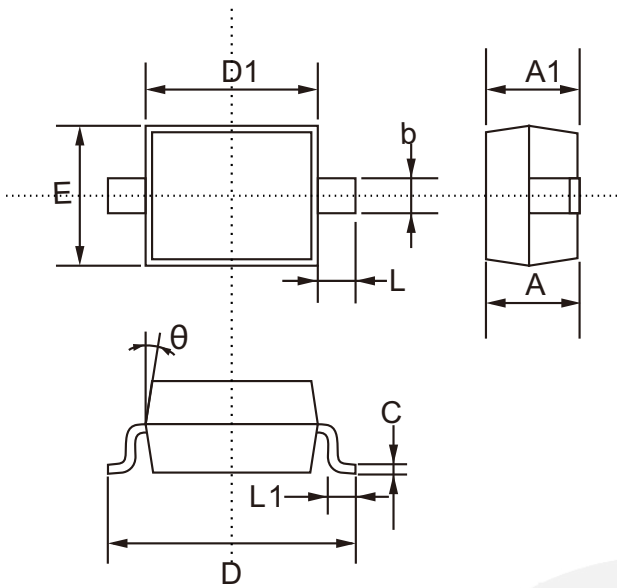
Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Test condition	Min	Typ	Max	Unit
Maximum forward voltage	V _{F1}	I _F = 0.1mA			240	mV
	V _{F2}	I _F = 1.0mA			320	
	V _{F3}	I _F = 10mA			400	
	V _{F4}	I _F = 30mA			500	
	V _{F5}	I _F = 100mA			1000	
Maximum reverse breakdown voltage	V _R	I _R =100uA	30			V
Maximum reverse current	I _R	V _R =25V			2.0	uA
Type junction capacitance	C _j	V _R = 1.0V, f = 1MHz			10	pF
Reverse Recovery Time	T _{rr}	I _F =10mA, I _{rr} =0.1xI _R , I _R =10mA			5	nS

Electrical characteristics Curves
Fig.1 Forward Characteristics

Fig.2 Reverse Characteristics

Fig.3 Capacitance Characteristics

Fig.4 Power Derating Curve


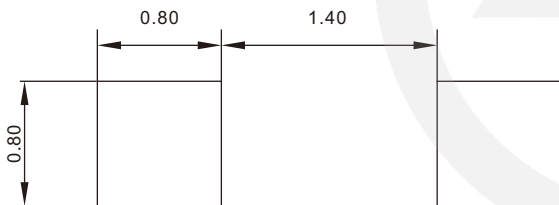
SOD-323 Package Outline

Unit: mm

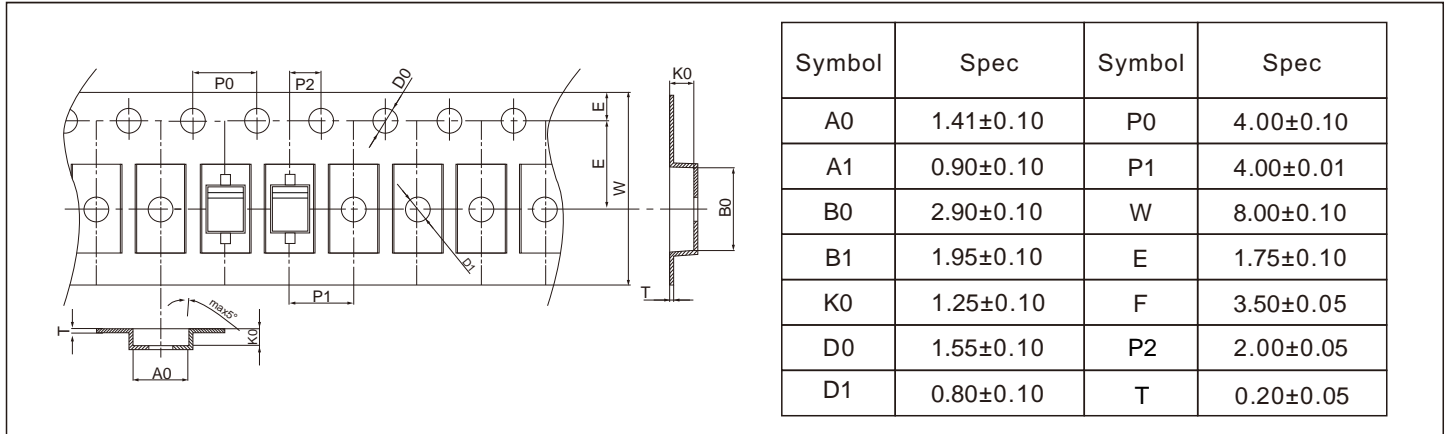
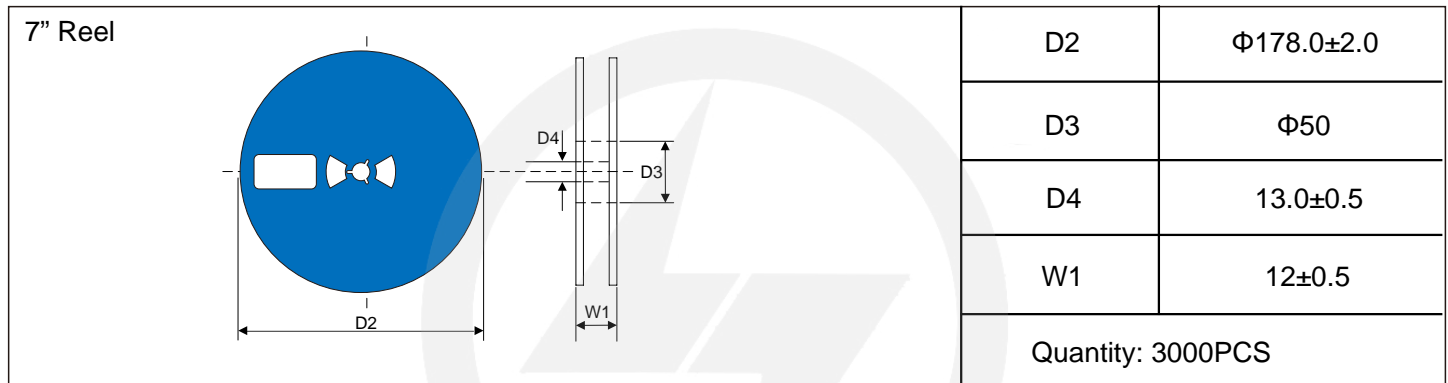
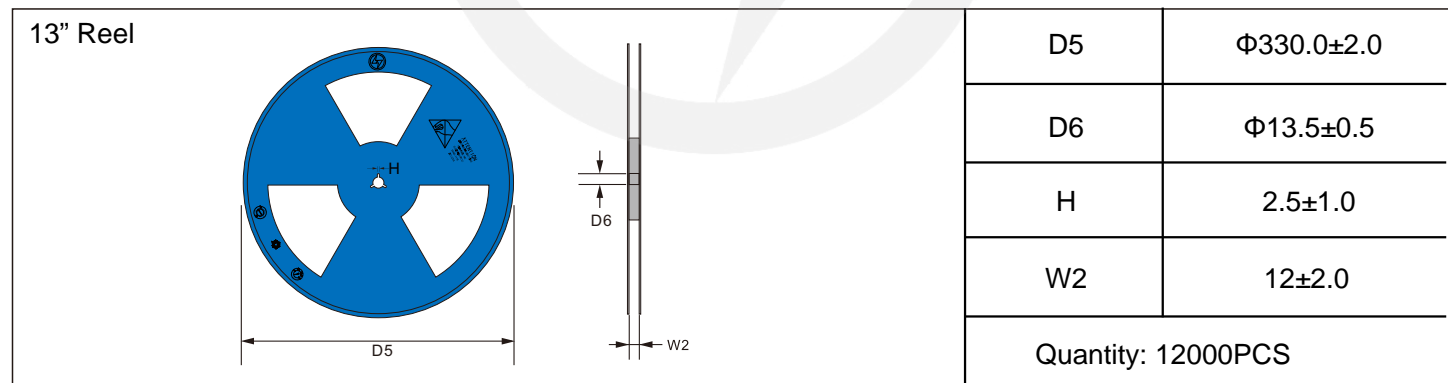
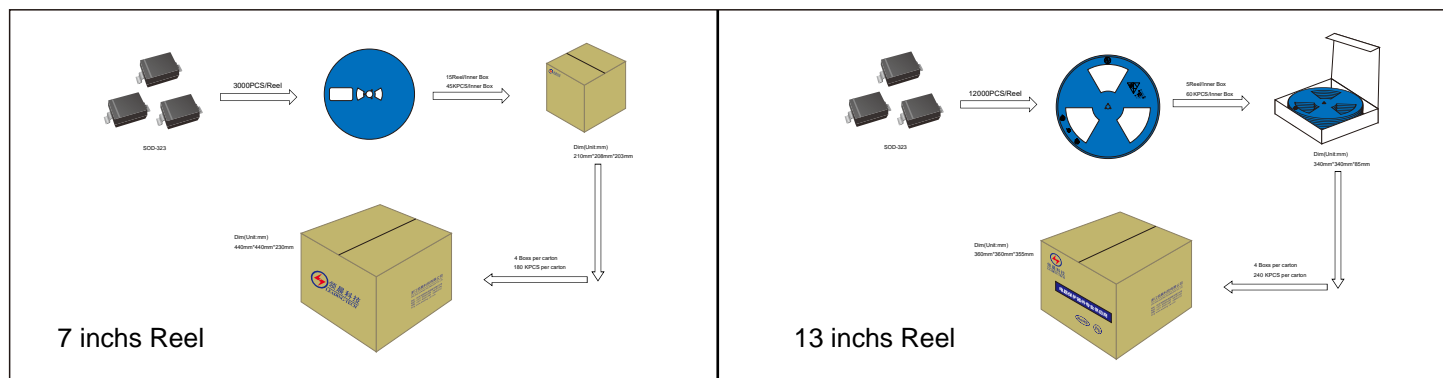


SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.800	1.100
A1	0.800	0.900
b	0.250	0.400
C	0.080	0.177
D	2.300	2.800
D1	1.400	1.800
E	1.150	1.400
L1	0.100	0.400
L	0.475 TYP.	
θ	8°	

SOD-323 Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$
 3. The pad layout is for reference purpose only.

Carrier Tape Dimensions
Unit : mm

Reel Dimensions
Unit : mm

Reel Dimensions
Unit : mm

Packaging




Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.
Preheat	
-Temperature Min ($T_{S\ min}$)	150°C
-Temperature Max ($T_{S\ max}$)	200°C
-Time (min to max) (t_s)	60-180 seconds
$T_{S\ max}$ to T_L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T_L)	217°C
-Time (t_L)	60-150 seconds
Peak Temperature (T_P)	260°C
Time within 5°C of actual Peak Temperature (t_p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.03.16	2024.03.16	3.0	New File	/	Ding	
02	2025.06.17	2025.06.17	3.1	Update packaging information	/	Ding	